

## SECTION B — PERFORMING OPERATIONS; TRANSPORTING

### B81 MICRO-STRUCTURAL TECHNOLOGY

**B81B MICRO-STRUCTURAL DEVICES OR SYSTEMS, e.g. MICRO-MECHANICAL DEVICES** (piezo-electric, electrostrictive or magnetostrictive elements per se H01L 41/00) [7]

#### Note(s) [7]

1. This subclass does not cover:
  - purely electrical or electronic devices per se which are covered by section H, e.g. subclass H01L;
  - purely optical devices per se which are covered by subclasses G02B or G02F;
  - essentially two-dimensional structures, e.g. layered products which are covered by subclass B32B;
  - chemical or biological structures per se which are covered by section C;
  - structures in atomic scale produced by manipulation of single atoms or molecules, which are covered by group B82B 1/00.
2. Devices or systems classified in this subclass are also classified in appropriate subclasses providing for their structural or functional features, if such features are of interest.

- 1/00 Devices without movable or flexible elements, e.g. micro-capillary devices [7, 2006.01]**
- 3/00 Devices comprising flexible or deformable elements, e.g. comprising elastic tongues or membranes (B81B 5/00 takes precedence) [7, 2006.01]**
- 5/00 Devices comprising elements which are movable in relation to each other, e.g. comprising slidable or rotatable elements [7, 2006.01]**

- 7/00 Micro-structural systems [7, 2006.01]**
- 7/02** • containing distinct electrical or optical devices of particular relevance for their function, e.g. micro-electro-mechanical systems (MEMS) (B81B 7/04 takes precedence) [7, 2006.01]
- 7/04** • Networks or arrays of similar micro-structural devices [7, 2006.01]